

# PGT880N030Q

30V 34A 8.8mΩ Si N-channel Enhancement Mode Split gate MOSFET

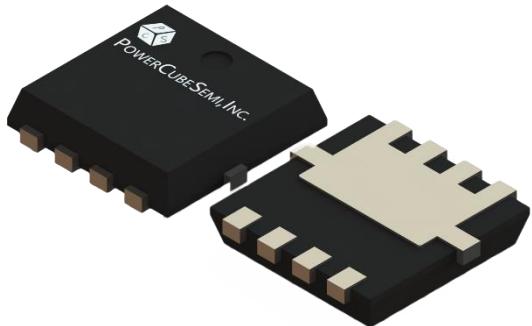
## Features

### Si N channel Enhancement Mode Split gate MOSFET

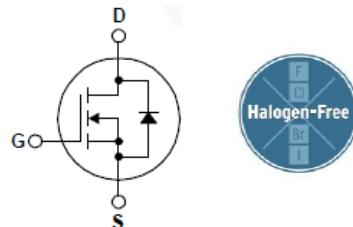
- Rated to 30V at 34Amps @ $T_C = 25^\circ\text{C}$
- Max  $R_{DS(on)} = 9.5 \text{ m}\Omega$
- Gate Charge(Typ.  $Q_G=20 \text{ nC}$ )
- Surface-mounted package
- Low Thermal Resistance

## Application

- DC-DC Converter
- Motor Drivers



PKG type : PDFN3333



## Absolute Maximum Ratings

$T_C=25^\circ\text{C}$  Unless Otherwise Noted

Symbol	Parameter	Test Condition	Value	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	30	V
$I_D^*$	Drain Current	$V_{GS}=10\text{V}, T_C=25^\circ\text{C}$	34	A
$I_{DM}^{*, **, ***}$	Pulsed Drain Current	$V_{GS}=10\text{V}, T_C=25^\circ\text{C}$	80	A
$V_{GS}$	Gate-Source Voltage	$T_C=25^\circ\text{C}$	$\pm 20$	V
$P_D^*$	Power Dissipation	$T_C=25^\circ\text{C}$	20.8	W
$T_J$	Junction Temperature		150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature		-55 to 150	$^\circ\text{C}$
$R_{\theta JA}^*$	Thermal Resistance – Junction to Ambient		62.5	$^\circ\text{C}/\text{W}$
$R_{\theta JC}^*$	Thermal Resistance – Junction to Case		6	$^\circ\text{C}/\text{W}$

### Note :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10 \text{ sec}$

\*\* Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 1\%$

\*\*\* Limited by bonding wire.

## Electrical Characteristics $T_C=25^\circ\text{C}$ Unless Otherwise Noted

### Static Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ.	Max.	
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	30	-	-	V
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	0.8	-	1.6	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}} = 24\text{V}, V_{\text{GS}} = 0\text{V}$	-	-	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$	-	-	$\pm 100$	nA
$R_{\text{DS}(\text{ON})}$	Static Drain-Source on state Resistance	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 20\text{A}$	-	8.8	9.5	$\text{m}\Omega$

### Dynamic Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ.	Max.	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=15\text{V}, f=1\text{MHz}$	-	918	-	pF
$C_{\text{oss}}$	Output Capacitance		-	114	-	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	101	-	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DS}}=15\text{V}, V_{\text{GEN}}=10\text{V}, R_{\text{G}}=4.5\Omega, R_{\text{L}}=0.75\Omega, I_{\text{DS}}=20\text{A}$	-	7	-	ns
$T_r$	Turn-On Rise Time		-	55	-	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		-	19	-	
$T_f$	Turn-Off Rise Time		-	23	-	

### Gate Charge Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ.	Max.	
$Q_G$	Total Gate Charge	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{DS}}=20\text{A}$	-	20	-	nC
$Q_{\text{GS}}$	Gate-Source Charge		-	3.6	-	
$Q_{\text{GD}}$	Gate-Drain Charge		-	3.9	-	

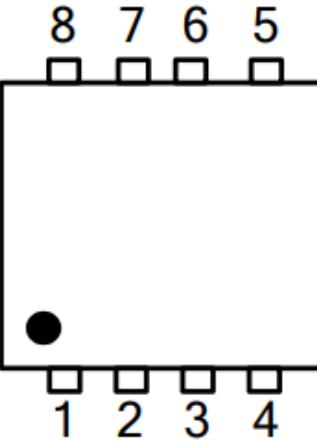
### Diode Characteristics

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ.	Max.	
$V_{\text{SD}}$	Diode Forward Voltage	$I_{\text{SD}}=20\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.3	V
$T_{\text{rr}}$	Reverse Recovery Time	$I_{\text{DS}}=20\text{A}, V_{\text{GS}}=0\text{V}, dI_{\text{SD}}/dt=100\text{A}/\mu\text{s}$	-	16	-	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		-	7	-	nC

## Package Marking and Ordering Information

Device Marking	Device	Package	Packing Method	Tape width	Quantity
PGT880N030Q	PGT880N030	PDFN3333			5000 Unit

## Pin Description

Pin	Description	Simplified Outline
1, 2, 3	Source (S)	
4	Gate (G)	
5, 6, 7, 8	Drain (D)	

## Typical Characteristics

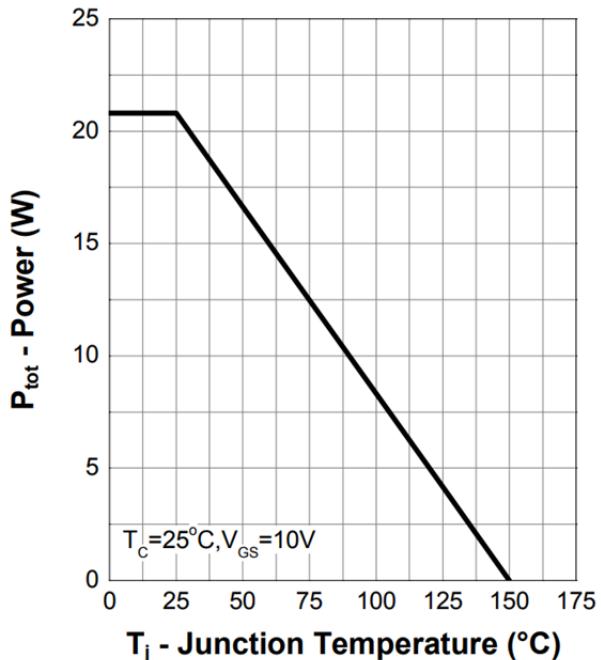


Figure 1. Power Capability

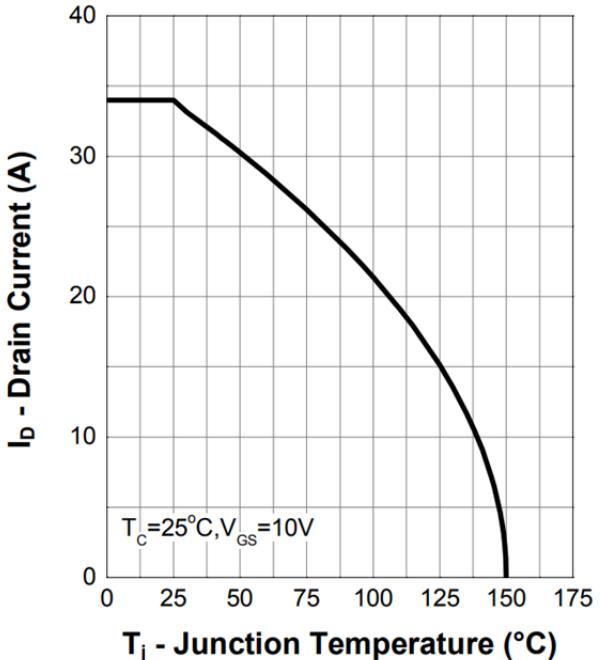


Figure 2. Current Capability

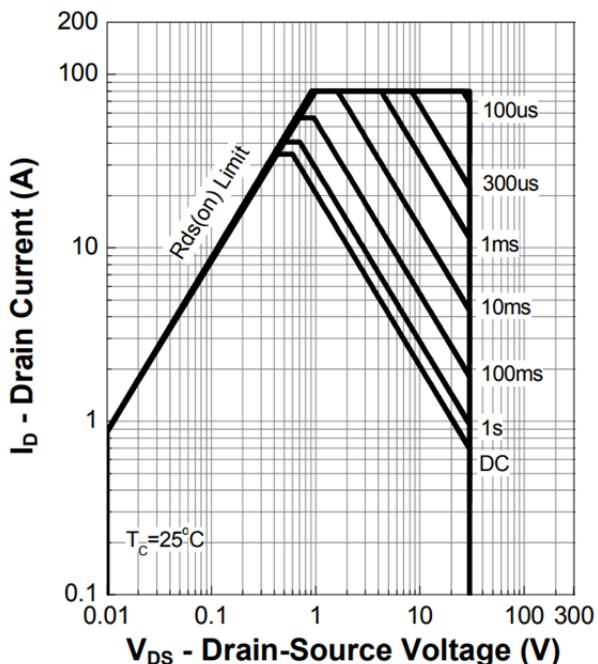


Figure 3. Safe Operating Area

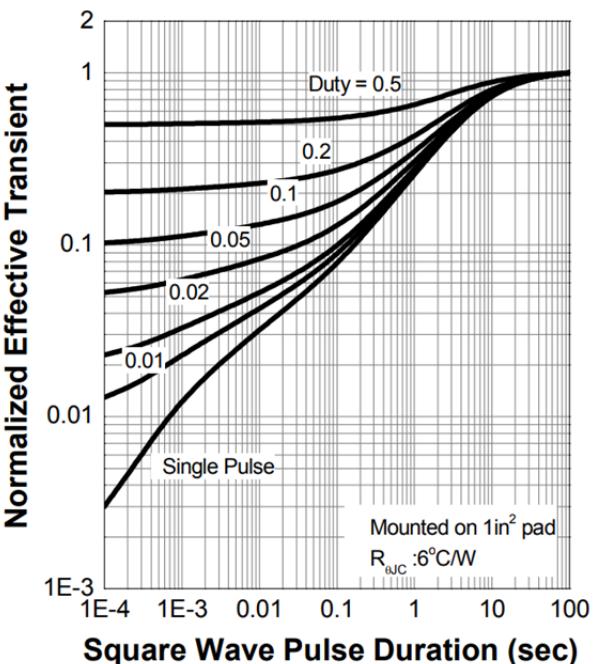


Figure 4. Transient Thermal Impedance

## Typical Characteristics

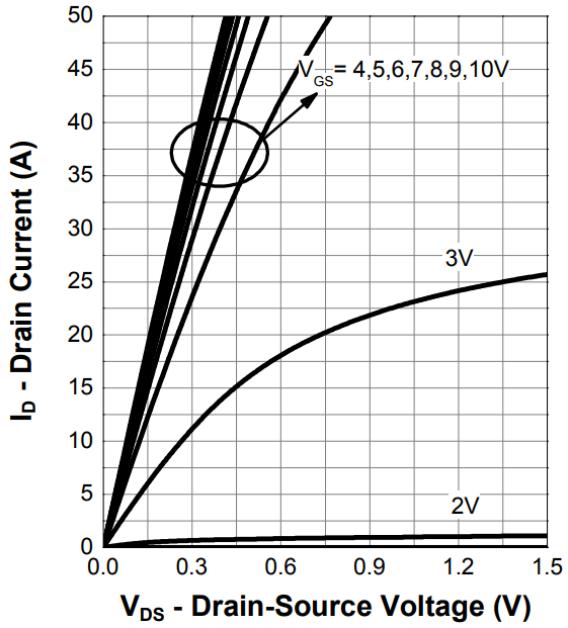


Figure 5. Output Characteristics

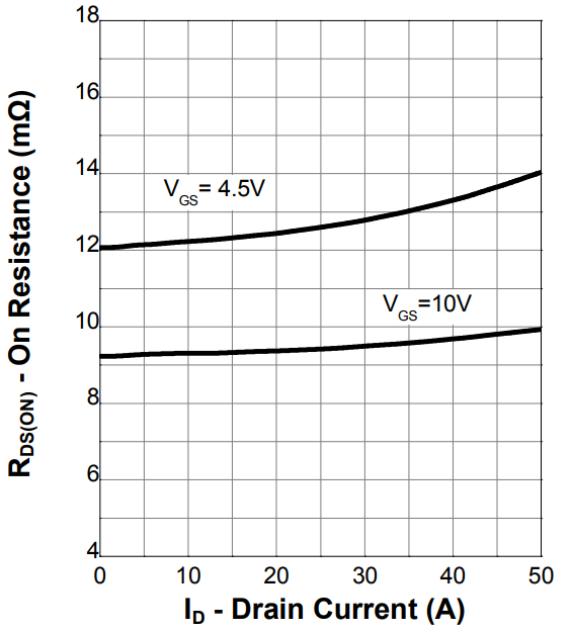


Figure 6. On-Resistance

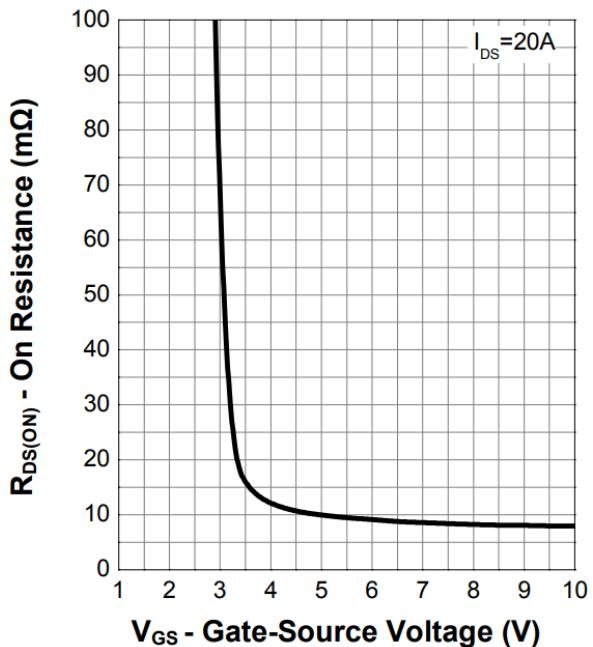


Figure 7. Transfer Characteristics

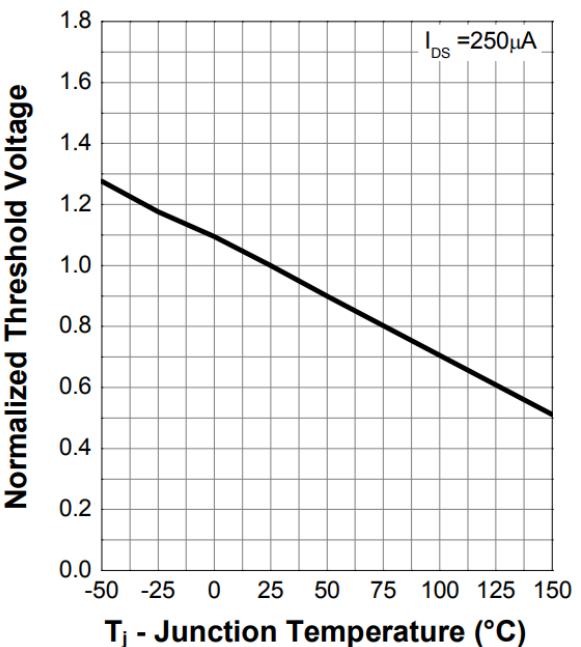


Figure 8. Normalized Threshold Voltage

## Typical Characteristics

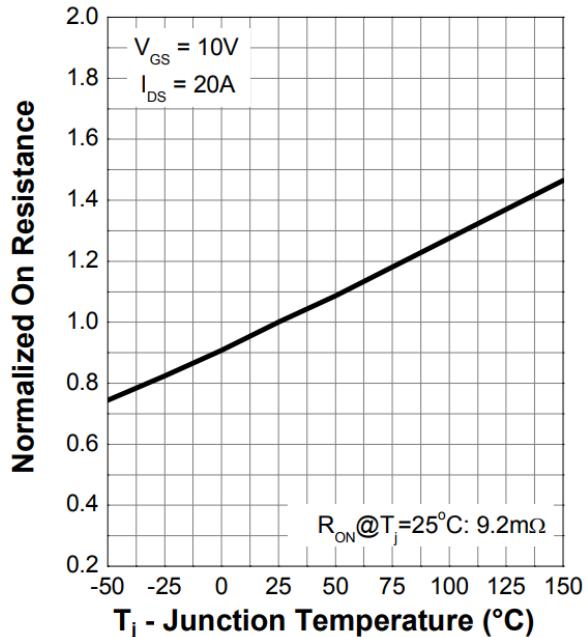


Figure 9. Normalized On-Resistance

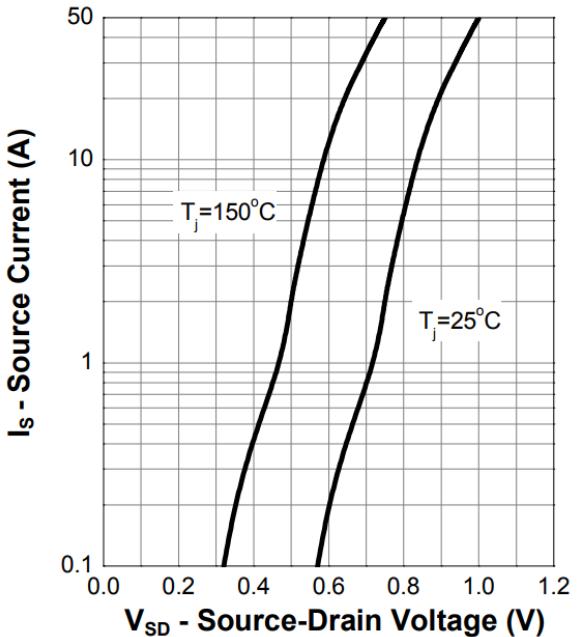


Figure 10. Diode Forward Current

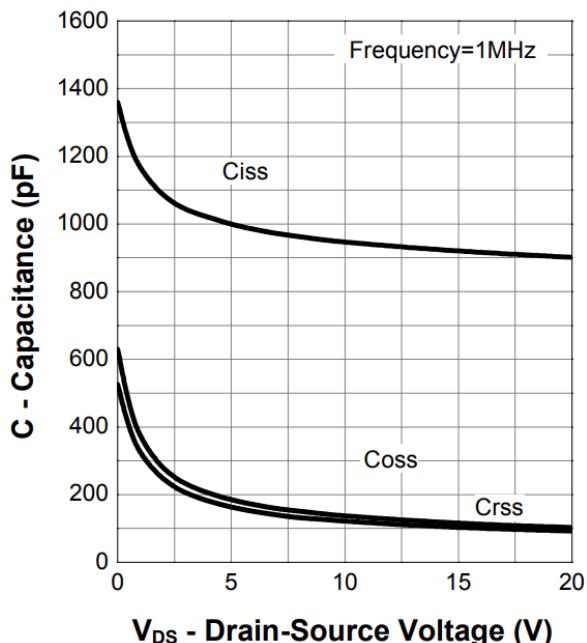


Figure 11. Capacitance

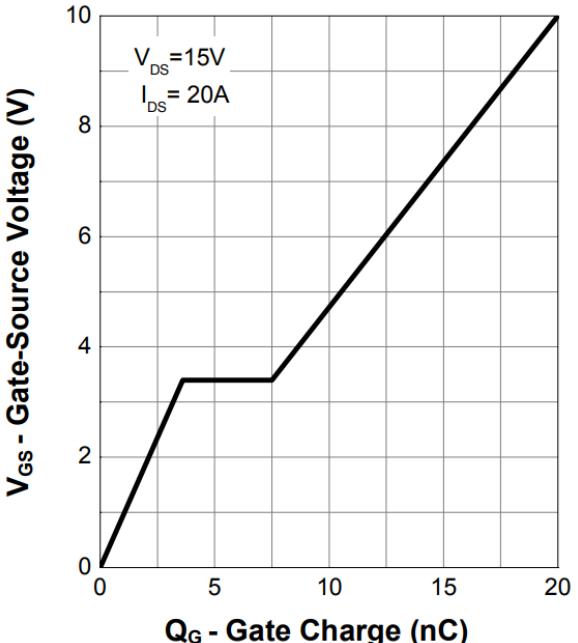
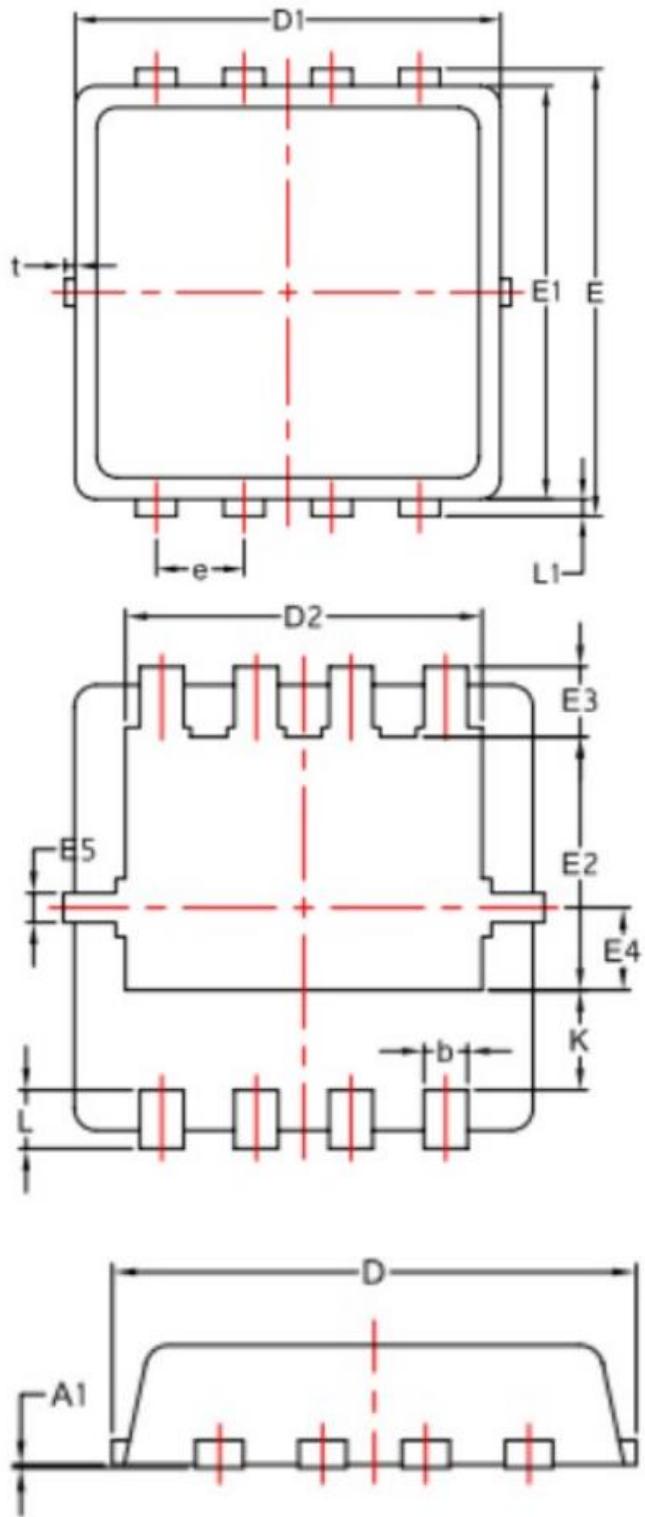


Figure 12. Gate Charge



### Package Outline



Unit : mm

SYMBOL	DIMENSION		
	MIN	NOM	MAX
<b>A</b>	0.70	0.75	0.85
<b>A1</b>	-	-	0.05
<b>b</b>	0.20	0.30	0.40
<b>c</b>	0.10	0.152	0.25
<b>D</b>	3.15	3.30	3.45
<b>D1</b>	3.00	3.15	3.25
<b>D2</b>	2.29	2.45	2.65
<b>E</b>	3.15	3.30	3.45
<b>E1</b>	2.90	3.05	3.20
<b>E2</b>	1.54	1.74	1.94
<b>E3</b>	0.28	0.48	0.65
<b>E4</b>	0.37	0.57	0.77
<b>E5</b>	0.10	0.20	0.30
<b>e</b>	0.60	0.65	0.70
<b>K</b>	0.59	0.69	0.89
<b>L</b>	0.30	0.40	0.50
<b>L1</b>	0.06	0.125	0.20
<b>t</b>	0	0.075	0.13
<b>θ</b>	<b>10°</b>	<b>12°</b>	<b>14°</b>

